### SN54F20, SN74F20 DUAL 4-INPUT POSITIVE-NAND GATES

SDFS041A - MARCH 1987 - REVISED OCTOBER 1993

 Package Options Include Plastic Small-Outline Packages, Ceramic Chip Carriers, and Standard Plastic and Ceramic 300-mil DIPs

#### description

These devices contain two independent 4-input NAND gates. They perform the Boolean functions  $Y = \overline{A} \cdot \overline{B} \cdot \overline{C} \cdot \overline{D}$  or  $Y = \overline{A} + \overline{B} + \overline{C} + \overline{D}$  in positive logic.

The SN54F20 is characterized for operation over the full military temperature range of  $-55^{\circ}$ C to 125°C. The SN74F20 is characterized for operation from 0°C to 70°C.

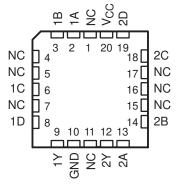
FUNCTION TABLE

	(each gate)											
	INP	OUTPUT										
Α	В	С	D	Y								
н	Н	Н	Н	L								
L	Х	Х	Х	н								
Х	L	Х	Х	н								
Х	Х	L	Х	н								
Х	Х	Х	L	н								

#### SN74F20 ... D OR N PACKAGE (TOP VIEW) 1A 14 V<sub>CC</sub> 1B 13 2D 2 NC 12 2C 3 1C 4 11 NC Ш 1D 10 2B 5 1Y 9**∏** 2A 6 8 2Y GND 7

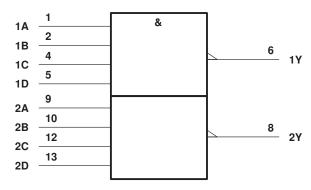
SN54F20 ... J PACKAGE

SN54F20 . . . FK PACKAGE (TOP VIEW)



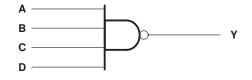
NC - No internal connection

#### logic symbol<sup>†</sup>



<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for the D, J, and N packages.

#### logic diagram, each gate (positive logic)



PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



### SN54F20, SN74F20 DUAL 4-INPUT POSITIVE-NAND GATES

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#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

Supply voltage range, V <sub>CC</sub>	
Input voltage range, V <sub>I</sub> (see Note 1)	–1.2 V to 7 V
Input current range	30 mA to 5 mA
Voltage range applied to any output in the high state	$\dots -0.5$ V to V <sub>CC</sub>
Current into any output in the low state	40 mĂ
Operating free-air temperature range: SN54F20	
SN74F20	0°C to 70°C
Storage temperature range	. −65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The input voltage ratings may be exceeded provided the input current ratings are observed.

#### recommended operating conditions

		SN54F20			5	UNIT		
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
V <sub>CC</sub>	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2			2			V
VIL	Low-level input voltage			0.8			0.8	V
Iк	Input clamp current			-18			-18	mA
ЮН	High-level output current			- 1			- 1	mA
IOL	Low-level output current			20			20	mA
TA	Operating free-air temperature	-55		125	0		70	°C

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	те	TEST CONDITIONS				5	UNIT		
PARAMETER		STCONDITIONS	MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT
VIK	V <sub>CC</sub> = 4.5 V,	lj = - 18 mA			-1.2			-1.2	V
VOH	V <sub>CC</sub> = 4.5 V,	I <sub>OH</sub> = - 1 mA	2.5	3.4		2.5	3.4		V
VОН	V <sub>CC</sub> = 4.75 V,	I <sub>OH</sub> = - 1 mA				2.7			v
V <sub>OL</sub>	V <sub>CC</sub> = 4.5 V,	I <sub>OL</sub> = 20 mA		0.3	0.5		0.3	0.5	V
lı	$V_{CC} = 5.5 V,$	V <sub>I</sub> = 7 V			0.1			0.1	mA
IIH	$V_{CC} = 5.5 V,$	V <sub>I</sub> = 2.7 V			20			20	μA
Ι <sub>Ι</sub>	V <sub>CC</sub> = 5.5 V,	V <sub>I</sub> = 0.5 V			- 0.6			- 0.6	mA
los§	V <sub>CC</sub> = 5.5 V,	$V_{O} = 0$	-60		-150	-60		-150	mA
Іссн	V <sub>CC</sub> = 5.5 V,	$V_{I} = 0$		0.9	1.4		0.9	1.4	mA
ICCL	V <sub>CC</sub> = 5.5 V,	V <sub>I</sub> = 4.5 V		3.4	5.1		3.4	5.1	mA

<sup>‡</sup> All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ .

§ Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.



### SN54F20, SN74F20 DUAL 4-INPUT POSITIVE-NAND GATES

SDFS041A - MARCH 1987 - REVISED OCTOBER 1993

#### switching characteristics (see Note 2)

PARAMETER	FROM (INPUT)	то (оитрит)	CI RI	V <sub>CC</sub> = 5 V, C <sub>L</sub> = 50 pF, R <sub>L</sub> = 500 Ω, T <sub>A</sub> = 25°C			$V_{CC} = 4.5 V \text{ to } 5.5 V,$ $C_L = 50 \text{ pF},$ $R_L = 500 \Omega,$ $T_A = \text{MIN to MAX}^{\dagger}$ SN54F20 SN74F20			
			MIN	ТҮР	MAX	MIN	MAX	MIN	MAX	
<sup>t</sup> PLH	A, B, C, or D	Y	1.6	3.3	5	1.2	7	1.6	6	ns
<sup>t</sup> PHL	A, B, C, O D		1	2.8	4.3	1	6.5	1	5.3	

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. NOTE 2: Load circuits and waveforms are shown in Section 1.





#### PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
5962-9758401Q2A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962- 9758401Q2A SNJ54F 20FK	Samples
5962-9758401QCA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-9758401QC A SNJ54F20J	Samples
5962-9758401QDA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-9758401QD A SNJ54F20W	Samples
JM38510/33004B2A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 33004B2A	Samples
JM38510/33004BCA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 33004BCA	Samples
JM38510/33004BDA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 33004BDA	Samples
M38510/33004B2A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 33004B2A	Samples
M38510/33004BCA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 33004BCA	Samples
M38510/33004BDA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 33004BDA	Samples
SN54F20J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54F20J	Samples
SN74F20D	LIFEBUY	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	F20	
SN74F20DR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	F20	Samples
SN74F20DRE4	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	F20	Samples
SN74F20N	ACTIVE	PDIP	Ν	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74F20N	Samples
SN74F20NSR	ACTIVE	SO	NS	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74F20	Samples
SNJ54F20FK	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962- 9758401Q2A	Samples

Orderable Device		Package Type		Pins		Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	Dan material	(3)		(4/5)	
							(6)				
										SNJ54F	
										20FK	
SNJ54F20J	ACTIVE	CDIP	J	14	1	Non-RoHS	SNPB	N / A for Pkg Type	-55 to 125	5962-9758401QC	Samples
						& Green				А	Samples
										SNJ54F20J	
SNJ54F20W	ACTIVE	CFP	W	14	1	Non-RoHS	SNPB	N / A for Pkg Type	-55 to 125	5962-9758401QD	Somulas
						& Green		0 11		Α	Samples
										SNJ54F20W	

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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### PACKAGE OPTION ADDENDUM

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

#### OTHER QUALIFIED VERSIONS OF SN54F20, SN74F20 :

• Catalog : SN74F20

Military : SN54F20

NOTE: Qualified Version Definitions:

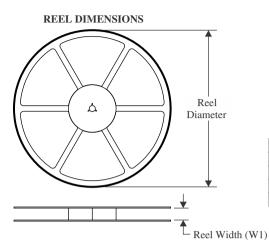
#### Catalog - TI's standard catalog product

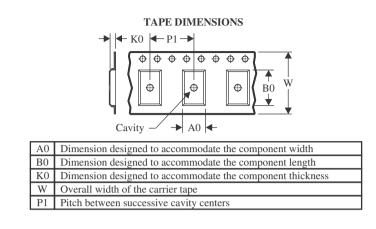
• Military - QML certified for Military and Defense Applications



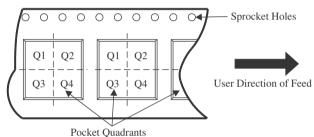
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#### TAPE AND REEL INFORMATION





#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



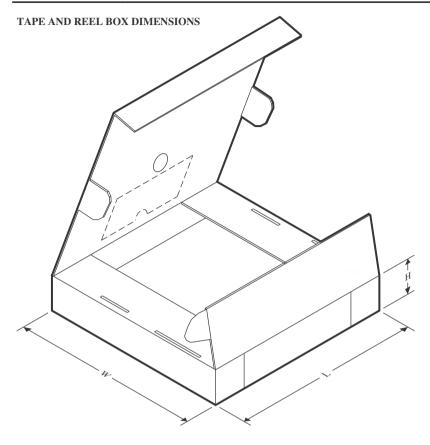
*All	dimensions are nominal												
	Device		Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
	SN74F20DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
	SN74F20NSR	SO	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1



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## PACKAGE MATERIALS INFORMATION

9-Aug-2022



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74F20DR	SOIC	D	14	2500	356.0	356.0	35.0
SN74F20NSR	SO	NS	14	2000	356.0	356.0	35.0

#### **Texas NSTRUMENTS**

\*All dimensions are nominal

SN74F20N

SN74F20N

SNJ54F20FK

SNJ54F20W

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W (mm)

12.06

26.16

12.06

26.16

12.06

26.16

8

13.97

13.97

12.06

26.16

506

506

506.98

506.98

Τ (μm)

2030

6220

2030

6220

2030

6220

3940

11230

11230

2030

6220

B (mm)

NA

NA

NA

NA

NA

NA

4.32

4.32

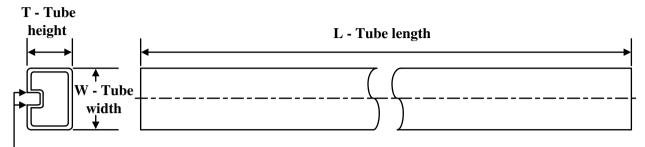
4.32

NA

NA

9-Aug-2022

#### TUBE



14

14

20

14

25

25

1

1

### **B** - Alignment groove width

Device	Package Name	Package Type	Pins	SPQ	L (mm)
5962-9758401Q2A	FK	LCCC	20	1	506.98
5962-9758401QDA	w	CFP	14	1	506.98
JM38510/33004B2A	FK	LCCC	20	1	506.98
JM38510/33004BDA	w	CFP	14	1	506.98
M38510/33004B2A	FK	LCCC	20	1	506.98
M38510/33004BDA	w	CFP	14	1	506.98
SN74F20D	D	SOIC	14	50	506.6

PDIP

PDIP

LCCC

CFP

Ν

Ν

FK

W

#### MECHANICAL DATA

#### PLASTIC SMALL-OUTLINE PACKAGE

#### 0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 $\bigcirc$ Gage Plane ₽ 0,25 7 1 1,05 0,55 0-10 Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS \*\* 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G\*\*)

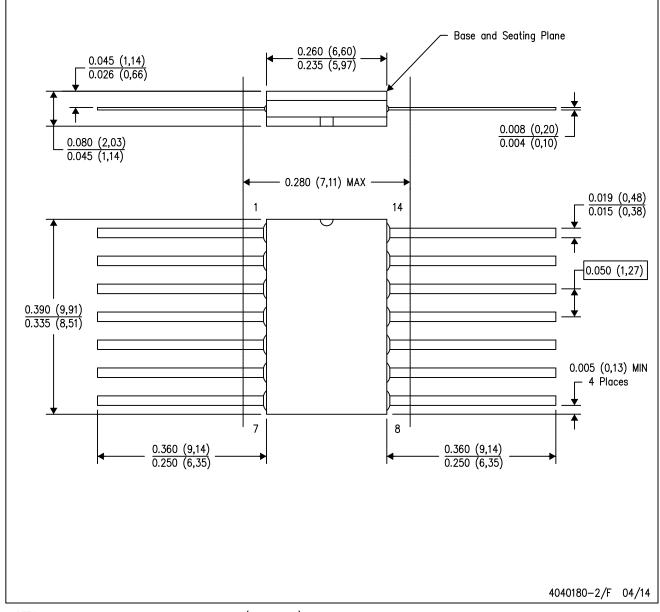
**14-PINS SHOWN** 

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



W (R-GDFP-F14)

CERAMIC DUAL FLATPACK



- NOTES: A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package can be hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only.
  - E. Falls within MIL STD 1835 GDFP1-F14



# FK 20

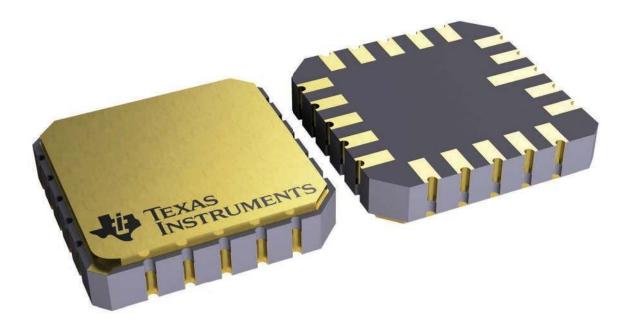
#### 8.89 x 8.89, 1.27 mm pitch

# **GENERIC PACKAGE VIEW**

### LCCC - 2.03 mm max height

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.

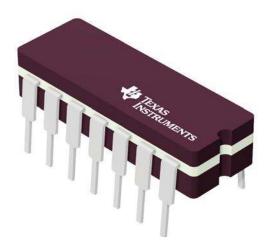




### **GENERIC PACKAGE VIEW**

# CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



# **J0014A**



# **PACKAGE OUTLINE**

### CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



NOTES:

- 1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This package is hermitically sealed with a ceramic lid using glass frit.
- Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
  Falls within MIL-STD-1835 and GDIP1-T14.



## J0014A

# **EXAMPLE BOARD LAYOUT**

### CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE





D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.





NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



### N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- $\triangle$  The 20 pin end lead shoulder width is a vendor option, either half or full width.



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